# Power Supply Miniaturization

Frederik Dostal, Field Applications Engineer

Miniaturization has always been a pervasive theme in the electronics industry and is especially important for power supplies. The quality of a power supply is often expressed in terms of power per volume. This article discusses a few power supply design considerations that can help achieve miniaturization.



Figure 1. A classic switching regulator with a semiconductor as well as passive components.

### Minimize the Number of External Components

A power supply normally consists of at least one semiconductor and passive external components such as an inductor, capacitors, and a few resistors. Reducing the number of components to those shown in Figure 1 is the first step in reducing the size of the overall power supply.

If other functions, such as an adjustable output voltage or an adjustable soft start time, are needed, the number of passive components and thus the space requirements for the overall solution increase. The circuit in Figure 1 is an example of a switch-mode buck converter with a minimal number of required passive components.

### Minimize the Size of External Components

For the smallest possible output capacitor and inductor sizes, the switching regulator IC must have the highest possible switching frequency. The voltage ripple of the output voltage primarily behaves linearly with respect to the value and thus the size of the external components. For example, if the switching frequency is doubled, the required inductance value is halved for the same output voltage ripple. This allows for smaller designs. Figure 2 shows the space requirements of an LTC3307A switching regulator. Because of the high switching frequency of 3 MHz, a small inductor can be used.



Figure 2. Space requirements of a switch-mode voltage converter for an output current of 3 A.

#### Minimize the Size of Switching Regulator IC

The LTC33xx platform from Analog Devices consists of switch-mode step-down voltage converters that convert with high switching frequencies of up to 5 MHz. The products available through this platform are designed for various applications. The LTC33I5A has been optimized for space-constrained applications. It is a dual converter with two channels that can each deliver 2 A of output current in a wafer-level chip scale package (WLCSP) with dimensions of just 1.64 mm × 1.64 mm. The MAX77324 is also notable. This single-channel step-down switching regulator has an output current maximum of 1.5 A and comes in a housing size of 1.22 mm  $\times$  0.85 mm. Figure 3 shows the MAX77324 package footprint.



Figure 3. A switching regulator in an extremely small package.





Figure 4. The package outline of the dual buck regulator IC with dimensions of 1.64 mm  $\times$  1.64 mm.

#### Reduction in Size Through Integrated Inductor

Another way to reduce the size of the power supply circuit is to combine the inductor with the switching regulator IC. This combination is called a module. Integration makes it possible to reduce the edge length by allowing the inductor to be placed on the semiconductor IC. Another miniaturization obstacle can also be overcome through use of the inductor in the module as a thermal conductor and a heat sink. With the proper connection of the inductor to the silicon within the power module, heat from the semiconductor can be dissipated extremely well. Especially for small switching regulator ICs with high output currents, heat dissipation is becoming a bigger problem because the silicon cannot be used above the maximum allowable operating temperature.

There are many ways to reduce the size of a power supply using innovative techniques. This brief power management tip covered a few of them. Miniaturization brings with it additional, indirect advantages, such as lower costs due to smaller board space requirements, the possibility of building technical devices with higher functionality and thus greater benefit, and even lower transport costs due to smaller and lighter electronic devices.

#### About the Author

Frederik Dostal studied microelectronics at the University of Erlangen in Germany. Starting work in the power management business in 2001, he has been active in various applications positions including 4 years in Phoenix, Arizona, where he worked on switch-mode power supplies. He joined Analog Devices in 2009 and works as a field applications engineer for power management at ADI in München. He can be reached at frederik.dostal@analog.com.

Engage with the ADI technology experts in our online support community. Ask your tough design questions, browse FAQs, or join a conversation.

## ADI EngineerZone

SUPPORT COMMUNITY

Visit ez.analog.com



For regional headquarters, sales, and distributors or to contact customer service and technical support, visit analog.com/contact.

Ask our ADI technology experts tough questions, browse FAQs, or join a conversation at the EngineerZone Online Support Community. Visit ez.analog.com.

©2022 Analog Devices, Inc. All rights reserved. Trademarks and registered trademarks are the property of their respective owners.

TA23752-4/22